

1 **DECLARATION OF JOINT INVENTORS FOR PATENT APPLICATION**

2 As the below named inventor, I hereby declare that:

3 My residence, post office address and citizenship are as stated below
4 next to my name.

5 I believe I am the original, first and joint inventor of the subject matter
6 which is claimed and for which a patent is sought on the invention entitled:
7 Capacitor Constructions, DRAM Constructions, Semiconductive Material
8 Assemblies, Etching Processes, And Methods Of Forming Capacitors And
9 DRAMS, the specification of which is attached hereto.

10 I hereby state that I have reviewed and understand the contents of the
11 above-identified specification, including the claims.

12 I acknowledge the duty to disclose information known to me to be
13 material to patentability as defined in Title 37, Code of Federal Regulations
14 §1.56.

15 **PRIOR FOREIGN APPLICATIONS:**

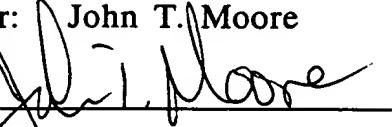
16 I hereby state that no applications for foreign patents or inventor's
17 certificates have been filed prior to the date of execution of this declaration.

18 I hereby declare that all statements made herein of my own knowledge
19 are true and that all statements made on information and belief are believed
20 to be true; and further that these statements were made with the knowledge
21 that willful false statements and the like so made are punishable by fine or
22 imprisonment, or both, under Section 1001 of Title 18 of the United States
23

1 Code and that such willful false statement may jeopardize the validity of the
2 application or any patent issued therefrom.

3 * * * * *

4 Full name of inventor: John T. Moore

5 Inventor's Signature: 

6 Date: 10/6/98

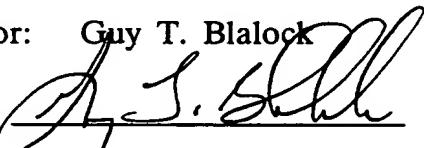
7 Residence: Boise, Idaho

8 Citizenship: U.S.

9 Post Office Address: 12530 W. Lexus Ct., Boise, ID 83713

10 * * * * *

11 Full name of inventor: Guy T. Blalock

12 Inventor's Signature: 

13 Date: 10/6/98

14 Residence: Boise, Idaho

15 Citizenship: U.S.

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17 * * * * *

18 Full name of inventor: Scott Jeffrey DeBoer

19 Inventor's Signature: 

20 Date: 10/6/98

21 Residence: Boise, Idaho

22 Citizenship: U.S.

23 Post Office Address: 259 E. Twin Willow, Boise, ID 83706